

# DENISTAT Z 15G 04

PPA resin, 15% glass fiber reinforced, semiconductive for injection moulding



PROPERTY	CONDITIONS	NORMS	UNITS	VALUE
<b>PHYSICAL PROPERTIES</b>				
Density	-	ISO-1183	g/cm <sup>3</sup>	1,37
Linear Mould Shrinkage	-	ASTM D-955	%	0,3
Trasversal Mould Shrinkage	-	ASTM D-955	%	0,7
<b>THERMAL PROPERTIES</b>				
Heat Distortion Temperature	HDT A (1,80 MPa)	ASTM D-648	°C	275
Long Term Temperature	-	Internal Method	°C	150
<b>MECHANICAL PROPERTIES</b>				
Impact Strength Izod Notched	23 °C	ISO-180/A	kJ/m <sup>2</sup>	6
Impact Strength Izod Unnotched	23 °C	ISO-180/U	kJ/m <sup>2</sup>	30
Tensile Strength at Break	23 °C	ISO-527/1-2	MPa	170
Elongation at Break	23 °C	ISO-527/1-2	%	1,5
Tensile Modulus	23 °C	ISO-527/1-2	MPa	16000
<b>ELECTRICAL PROPERTIES</b>				
Surface Resistivity	-	ASTM D257	Ohm	10 <sup>4</sup>

